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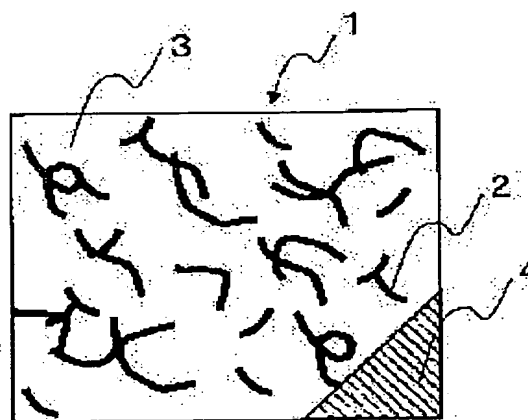
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(54) CARBON-CONTAINING RESIN COMPOSITION, MOLDING MATERIAL AND MOLDED PRODUCT**(57)Abstract:**

PROBLEM TO BE SOLVED: To provide a carbon-containing resin composition exhibiting excellence in mechanical characteristics and molding properties and, if required, combined with excellent electroconductivity, a molding material and a molded product composed thereof.

SOLUTION: The carbon-containing resin composition comprises at least the following constituents [A], [B] and [C], where the constituent [A] is uniformly dispersed in the constituent [B] without substantially forming aggregate or entanglement, the amount of the constituents [A] and [C] being within 0.01–1.8 wt.% and within 0.1–55 wt.%, respectively, based on 100 wt.% of the composition, where the constituent [A] is a carbon nanotube having an average diameter of 1–45 nm and an average aspect ratio of at least 5, the constituent [B] is a resin, and the constituent [C] is a filler. The molding material and the molded product are obtained by processing and molding the carbon-containing resin composition.

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